

FIG 1a

↓
FLIP
↓

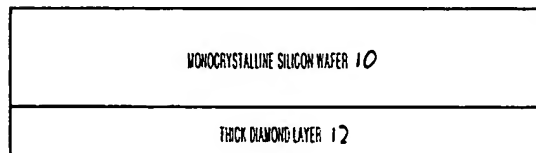


FIG 1b

↓
GRIND
↓

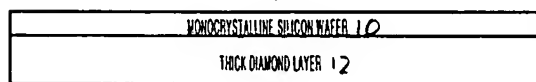


FIG 1c

↓
ETCH AND POLISH
↓

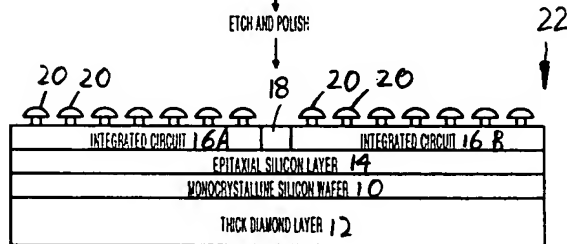


FIG 1d

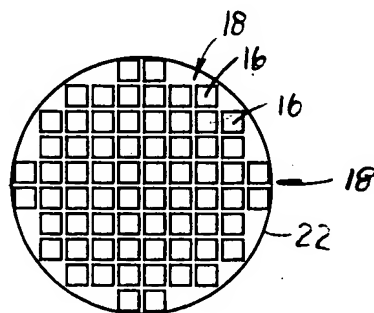


FIG 1e

↓
LASER CUT
↓

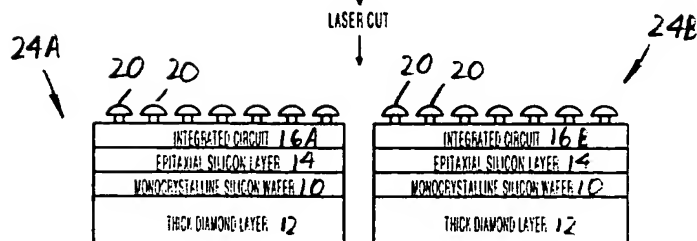


FIG 1f

28 →

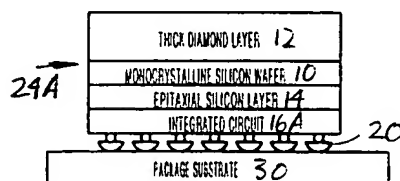


FIG 1g

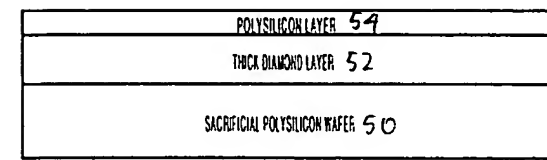


FIG 2a

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FLIP
↓

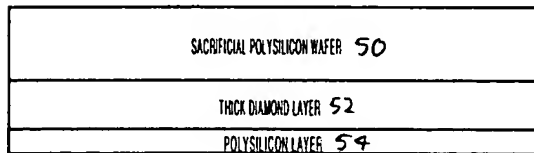


FIG 2b

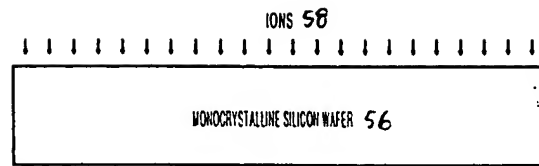


FIG 2c

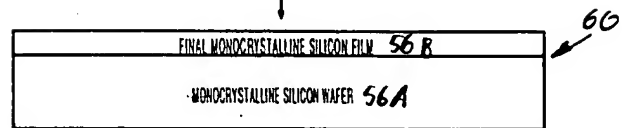


FIG 2d

↓
SILICON BOND
↓

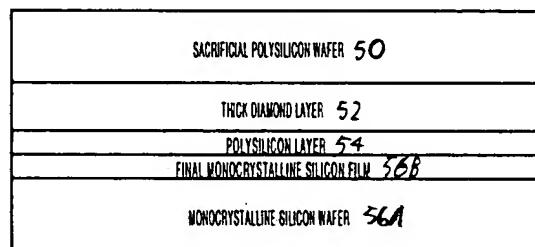


FIG 2e

↓
ETCH
↓

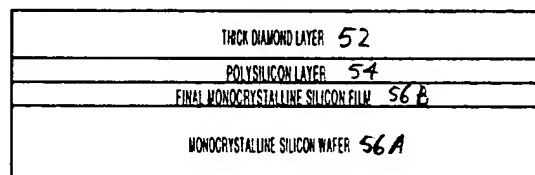


FIG 2f

↓
FLIP
↓

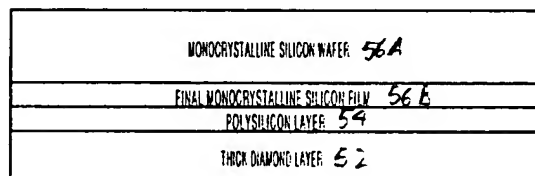


FIG 2g

↓
SPLIT
↓

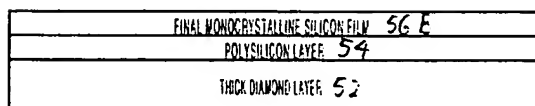


FIG 2h

↓
ETCH AND POLISH
↓

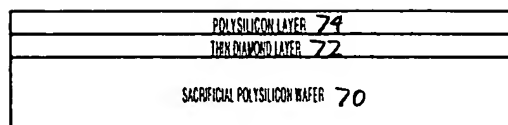


FIG 3a

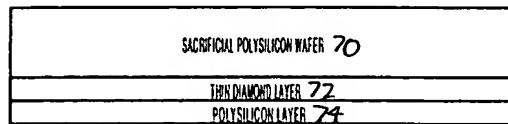


FIG 3b

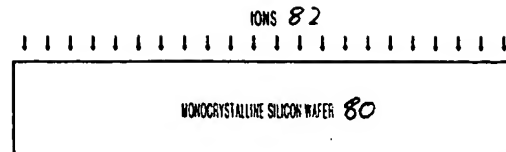


FIG 3c

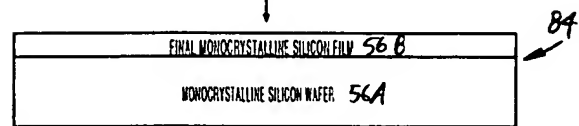


FIG 3d



SILICON BOND

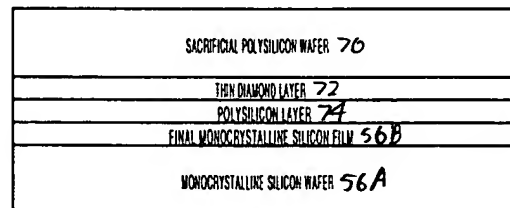
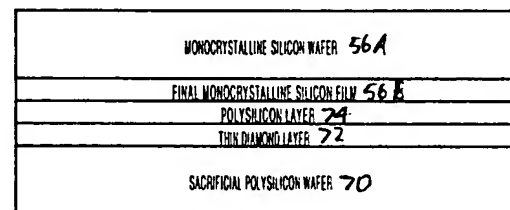


FIG 3e

FLIP



SEAL

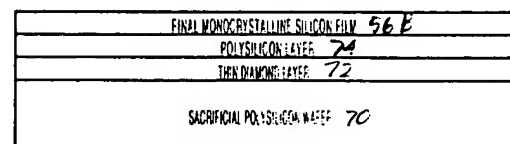


FIG 3g

ETCH AND POLISH

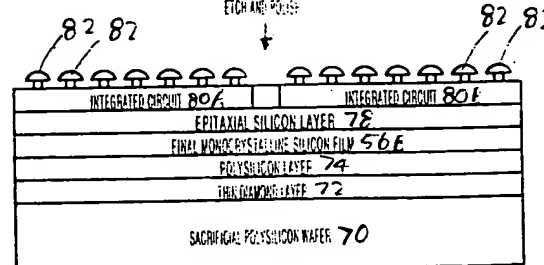


FIG 3h

FIG 3f

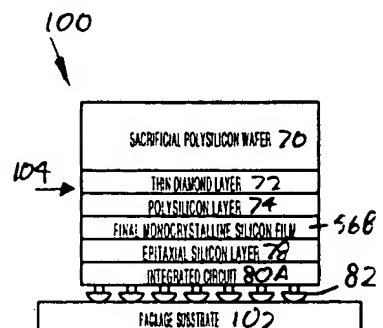


FIG 3i

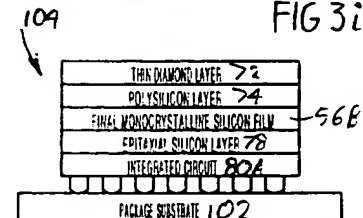


FIG 3j